



40V +175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _C = +25°C		
40V	15mΩ @ V _{GS} = 10V	43.6A		
400	25mΩ @ V _{GS} = 4.5V	33A		

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production –
 Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (DMTH4014LPDWQ)

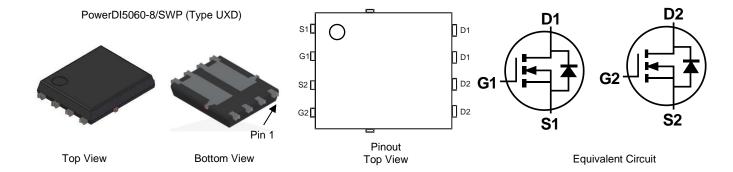
Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Backlighting
- Power-management functions
- DC-DC converters

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Orderable Part Number	Package	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMTH4014LPDW-13	PowerDI5060-8/SWP (Type UXD)	2,500	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



Marking Information



⊃¦¦ = Manufacturer's Marking
 TH4014LD = Product Type Marking Code
 YY
 YY
 YY = Year (ex: 24 = 2024)
 WW = Week (01 to 53)

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	40	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 5)	T _C = +25°C T _C = +100°C	I _D	43.6 30.8	А	
Continuous Drain Current (Note 6) Steady State		$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	lo	10.6 7.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	I _{DM}	174	Α		
Maximum Continuous Body Diode Forward Current (Note 6)			Is	36	Α
Avalanche Current, L = 0.3mH			las	11.7	Α
Avalanche Energy, L = 0.3mH			Eas	20.5	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5) $T_A = +25^{\circ}C$		P _D	2.4	W
Thermal Resistance, Junction to Ambient (Note 5) Steady State		Reja	62.6	°C/W
Total Power Dissipation (Note 6)	PD	42.8	W	
Thermal Resistance, Junction to Case (Note 6)	R ₀ JC	3.5	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.

^{6.} Thermal resistance from junction to soldering point (on the exposed drain pad).



Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	VGS = 0V, ID = 1mA	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	Vgs = ±20V, Vps = 0V	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	1	1.3	3	V	V _{DS} = V _{GS} , I _D = 250µA	
Static Drain-Source On-Resistance	D	_	11.8	15	mΩ	Vgs = 10V, ID = 20A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	17.9	25	11177	$V_{GS} = 4.5V, I_D = 15A$	
Diode Forward Voltage	VsD	_	0.9	1.2	V	V _G S = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	733	_	pF		
Output Capacitance	Coss	-	235	_	pF	$V_{DS} = 20V, V_{GS} = 0V$ - f = 1MHz	
Reverse Transfer Capacitance	Crss	_	24	_	pF	1 – 11011 12	
Gate Resistance	R_g	_	1.3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	5.2	_	nC		
Total Gate Charge (V _{GS} = 10V)	Q_g	-	10.2	_	nC	\/ 20\/ I= 20A	
Gate-Source Charge	Qgs	-	1.5	_	nC	$V_{DS} = 20V, I_{D} = 20A$	
Gate-Drain Charge	Q_{gd}	_	3.1	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	3.5	_	ns		
Turn-On Rise Time	t _R	_	5.7	_	ns	V _{DD} = 20V, V _{GS} = 10V	
Turn-Off Delay Time	tD(OFF)	_	8.7	_	ns	$R_g = 1.6\Omega, I_D = 20A$	
Turn-Off Fall Time	t _F	_	1.8	_	ns	1	
Body Diode Reverse-Recovery Time	trr	_	11.9	_	ns	154 11/11 1004/	
Body Diode Reverse-Recovery Charge	Qrr		9.28	_	nC	I _F = 15A, di/dt = 400A/μs	

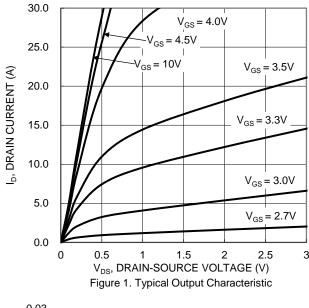
Notes:

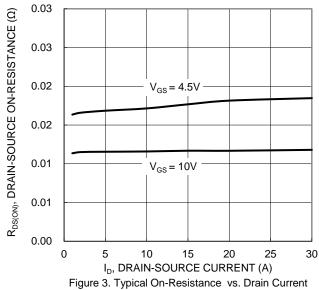
^{7.} Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.









and Gate Voltage

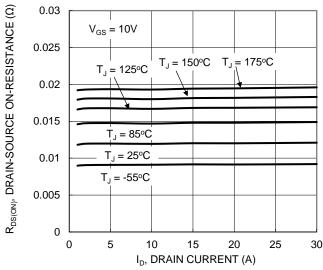
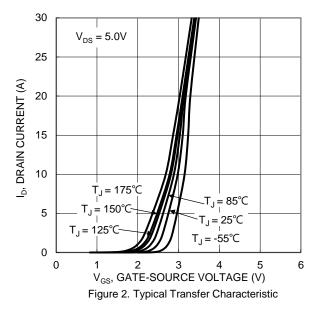
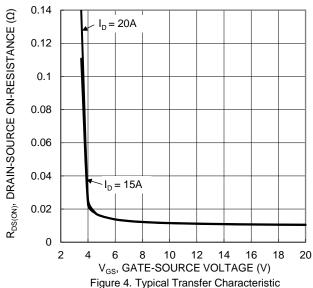


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





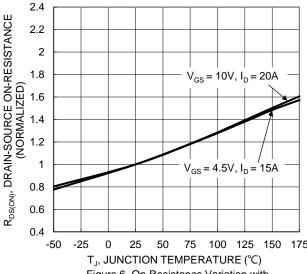


Figure 6. On-Resistance Variation with Temperature



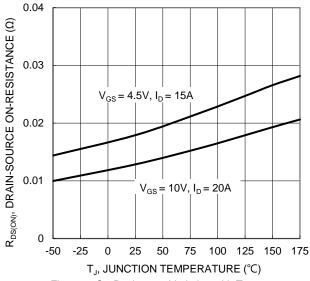


Figure 7. On-Resistance Variation with Temperature

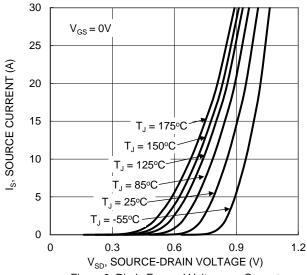


Figure 9. Diode Forward Voltage vs. Current

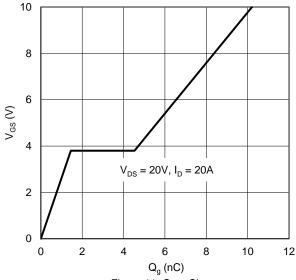


Figure 11. Gate Charge

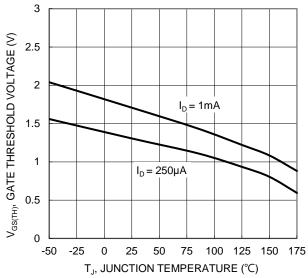
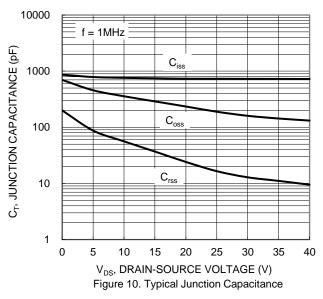


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R_{DS(ON)} 100 ID, DRAIN CURRENT (A) 10 $P_W = 10\mu s$ $P_{W} = 100 \mu s$ $T_{J(Max)} = 175$ °C $P_W = 10 ms$ $T_C = 25^{\circ}C$ $P_W = 100ms$ Single Pulse 0.1 DUT on Infinite $P_W = 1s$ Heatsink $V_{GS} = 10V$ 0.01 0.1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation A



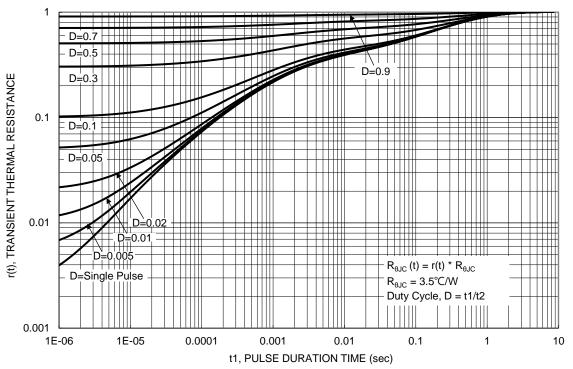


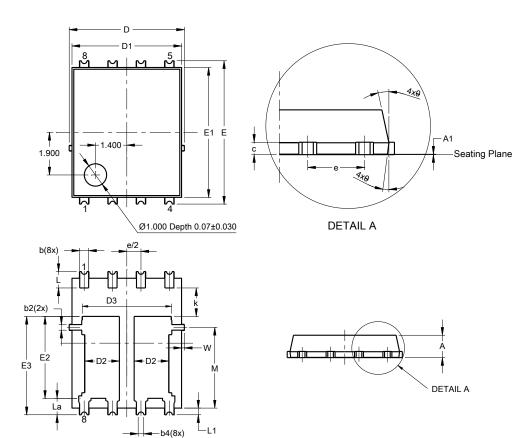
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)

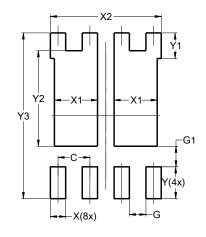


PowerDI5060-8/SWP					
(Type UXD)					
Dim	Min Max		Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF			
C	0.230	0.330	0.277		
D	5.15 BSC				
D1	4.70	5.10	4.90		
D2	1.46	1.66	1.55		
D3	3.78 4.18		3.98		
Е	6	.40 BS0)		
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05		-		
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
M	3.205	4.005	3.605		
W	0.025	0.225	0.125		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value			
פווטופווסוווט	(in mm)			
С	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	1.720			
X2	4.420			
Y	1.270			
Y1	1.020			
Y2	3.810			
Y3	6.610			



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